

512Kx8 Static RAM
CMOS, Monolithic

PRELIMINARY

The EDI88512C is a 4 megabit Monolithic CMOS Static RAM.

The 32 pin DIP pinout adheres to the JEDEC standard for the four megabit device and is a pin for pin replacement for the 512Kx8 module, EDI8M8512C. All three 32 pin packages are pin for pin upgrades for the single chip enable 128K x 8, the EDI88128C. Pins 1 and 30 become the higher order addresses.

A Low Power version with Data Retention (EDI88512LP) is also available for battery backed applications.

Ceramic military product compliant to MIL-STD-883, paragraph 1.2.1 is available.

A non-compliant device is available in a plastic dual-in-line package which is tested over the full military temperature range, -55°C to +125°C, and undergoes 160 hours of burn-in at 125°C or the equivalent.

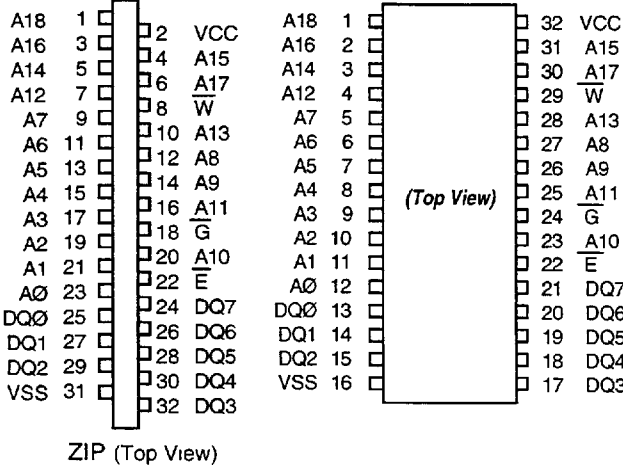
Features

512Kx8 bit CMOS Static Random Access Memory

- Access Times: 55,* 70, 85 and 100ns
 - Data Retention Function (LP version)
 - TTL Compatible Inputs and Outputs
 - Fully Static, No Clocks
- 32 lead, JEDEC Approved Pinout
- Ceramic Sidebraced DIP, No. 9
 - Ceramic ZIP, No. 100
 - Ceramic SOJ, No. 140
 - Plastic DIP, No.11
- Single +5V (±10%) Supply Operation

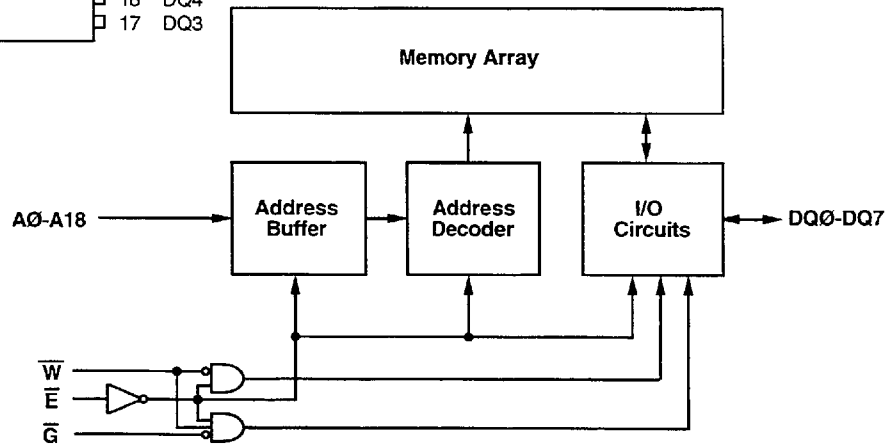
*Advance Information

Pin Configuration and Block Diagram



Pin Names

A0-A18	Address Inputs
E	Chip Enable
W	Write Enable
G	Output Enable
DQ0-DQ7	Common Data Input/Output
VCC	Power (+5V±10%)
VSS	Ground



Absolute Maximum Ratings*

Voltage on any pin relative to VSS	-0.5V to 7.0V
Operating Temperature TA (Ambient)	
Industrial	-40°C to +85°C
Military	-55°C to +125°C
Storage Temperature, Ceramic	-65°C to +150°C
Power Dissipation	1 Watt
Output Current	20 mA

*Stress greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Recommended DC Operating Conditions

Parameter	Sym	Min	Typ	Max	Units
Supply Voltage	VCC	4.5	5.0	5.5	V
Supply Voltage	VSS	0	0	0	V
Input High Voltage	VIH	2.2	--	6.0	V
Input Low Voltage	VIL	-0.3	--	0.8	V

AC Test Conditions

Input Pulse Levels	VSS to 3.0V
Input Rise and Fall Times	5ns
Input and Output Timing Levels	1.5V
Output Load	See Figure 1
	(note: For TEHQZ, TGHQZ and TWLQZ See Figure 2)

Figure 1

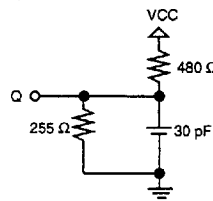
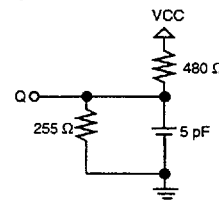


Figure 2



DC Electrical Characteristics

Parameter	Sym	Conditions	Min	Typ*	Max	Units	
Operating Power Supply Current	ICC1	$\bar{W}, \bar{E} = VIL, I/O = 0mA,$ Min Cycle	--	45	75	mA	
Standby (TTL) Power Supply Current	ICC2	$E \geq VIH, VIN \leq VIL, VIN \geq VIH$	--	3	10	mA	
Full Standby Power Supply Current	ICC3	$\bar{E} \geq VCC-0.2V$ $VIN \geq VCC-0.2V$ or $VIN \leq 0.2V$	C	--	--	5	mA
			LP	--	--	1	mA
Input Leakage Current	ILI	$VIN = 0V$ to VCC	--	--	± 10	μA	
Output Leakage Current	ILO	$V I/O = 0V$ to VCC	--	--	± 10	μA	
Output High Voltage	VOH	$IOH = -1.0mA$	2.4	--	--	V	
Output Low Voltage	VOL	$IOL = 2.1mA$	--	--	0.4	V	

*Typical: TA = 25°C, VCC = 5.0V

Truth Table

\bar{G}	\bar{E}	\bar{W}	Mode	Output	Power
X	H	X	Standby	High Z	ICC2, ICC3
H	L	H	Output Deselect	High Z	ICC1
L	L	H	Read	DOUT	ICC1
X	L	L	Write	DIN	ICC1

Capacitance

(f=1.0MHz, VIN=VCC or VSS)

Parameter	Sym	Max	Unit
Address Lines	CI	12	pF
Data Lines	CD/Q	14	pF

These parameters are sampled, not 100% tested.

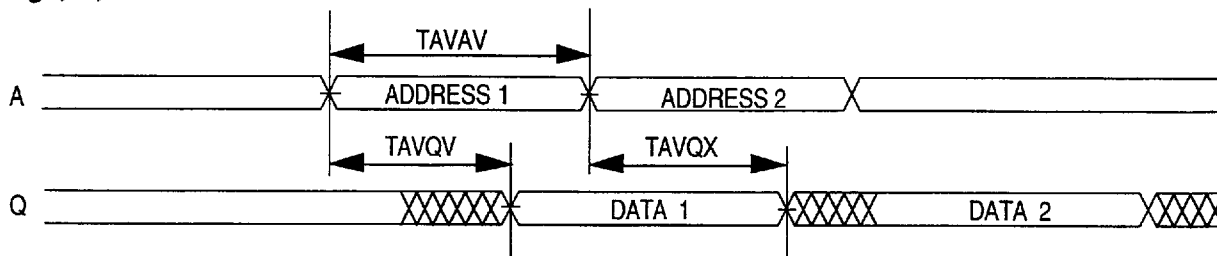
AC Characteristics

Read Cycle

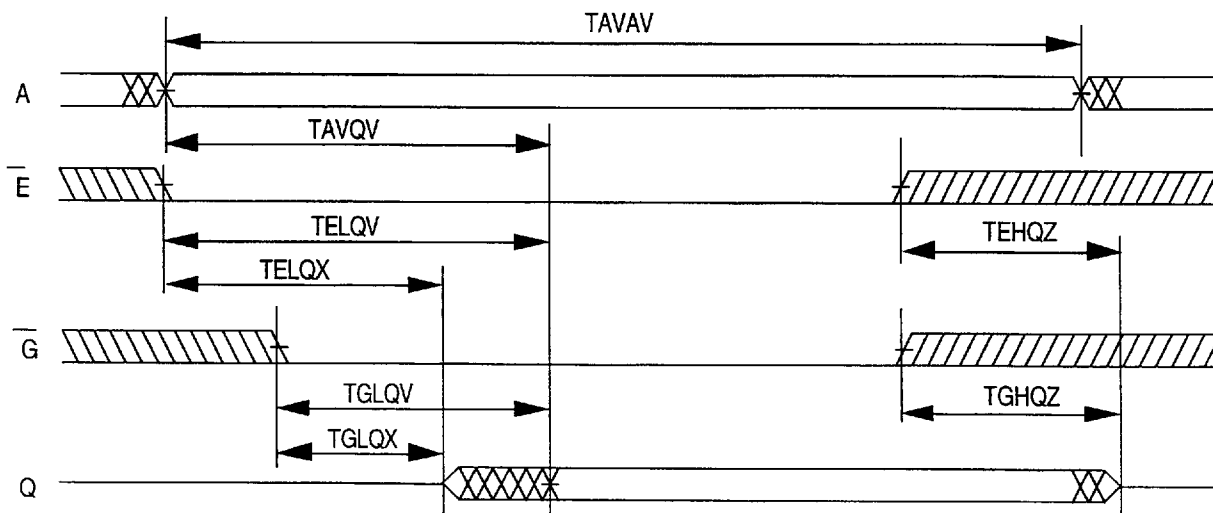
Parameter	Symbol		55ns		70ns		85ns		100ns		Units
	JEDEC	Alt.	Min	Max	Min	Max	Min	Max	Min	Max	
Read Cycle Time	TAVAV	TRC	55		70		85		100		ns
Address Access Time	TAVQV	TAA		55		70		85		100	ns
Chip Enable Access Time	TELQV	TACS		55		70		85		100	ns
Chip Enable to Output in Low Z (1)	TELQX	TCLZ	10		10		10		10		ns
Chip Disable to Output in High Z (1)	TEHQZ	TCHZ		20		25		30		30	ns
Output Hold from Address Change	TAVQX	TOH	10		10		10		10		ns
Output Enable to Output Valid	TGLQV	TOE		30		35		45		50	ns
Output Enable to Output in Low Z (1)	TGLQX	TLOZ	5		5		5		5		ns
Output Disable to Output in High Z(1)	TGHQZ	TOHZ	0	20	0	25	0	30	0	30	ns

Note 1: Parameter guaranteed, but not tested.

Read Cycle 1 W High; G, E Low



Read Cycle 2 W High



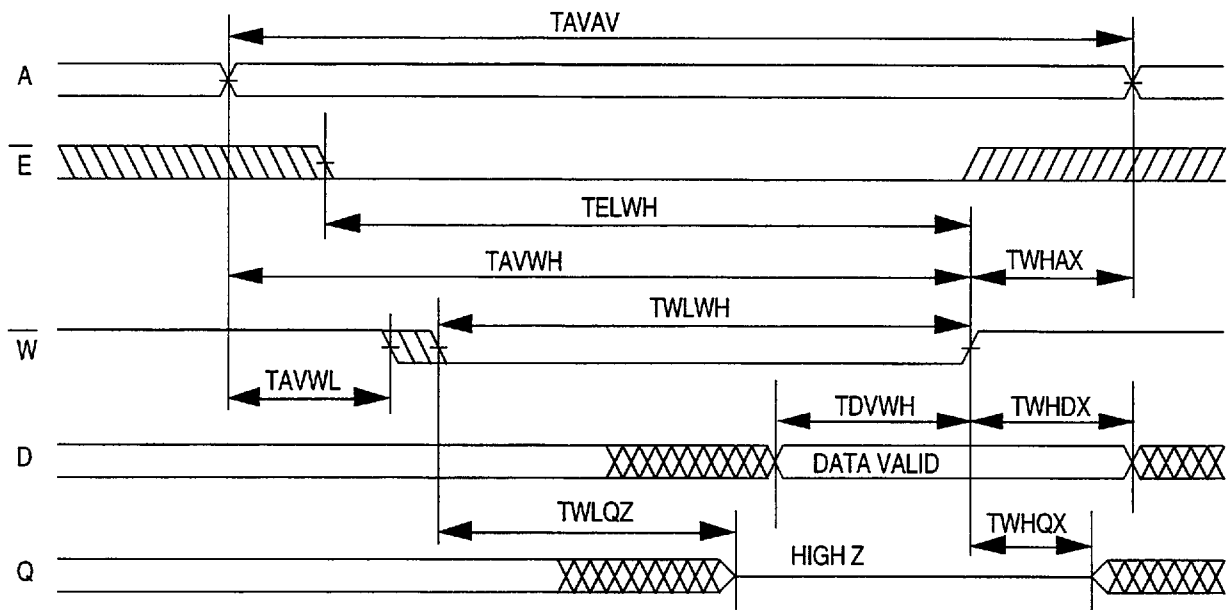
AC Characteristics

Write Cycle

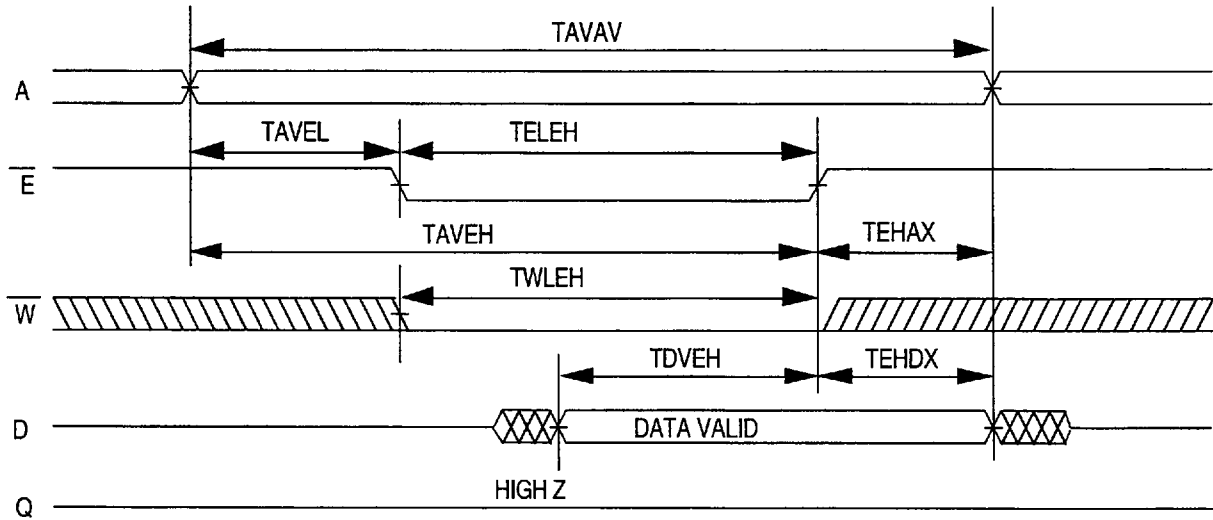
Parameter	Symbol		55ns		70ns		85ns		100ns		Units
	JEDEC	Alt.	Min	Max	Min	Max	Min	Max	Min	Max	
Write Cycle Time	TAVAV	TWC	55		70		85		100		ns
Chip Enable to End of Write	TELWH	TCW	50		60		70		80		ns
	TELEH	TCW	50		60		70		80		ns
Address Setup Time	TAVWL	TAS	0		0		0		0		ns
	TAVEL	TAS	0		0		0		0		ns
Address Valid to End of Write	TAVWH	TAW	50		65		70		80		ns
	TAVEH	TAW	50		65		70		80		ns
Write Pulse Width	TWLWH	TWP	45		50		55		60		ns
	TWLEH	TWP	45		50		55		60		ns
Write Recovery Time	TWHAX	TWR	0		0		0		0		ns
	TEHAX	TWR	0		0		0		0		ns
Data Hold Time in High Z (1)	TWHDX	TDH	0		0		0		0		ns
	TEHDX	TDH	0		0		0		0		ns
Write to Output in High Z	TWLQZ	TWHZ	0	25	0	25	0	30	0	30	ns
Data to Write Time	TDVWH	TDW	30		30		35		40		ns
	TDVEH	TDW	30		30		35		40		ns
Output Active from End of Write (1)	TWHQX	TWLZ	5		5		5		5		ns

Note 1: Parameter guaranteed, but not tested.

**Write Cycle 1
W Controlled**



**Write Cycle 2
E Controlled**



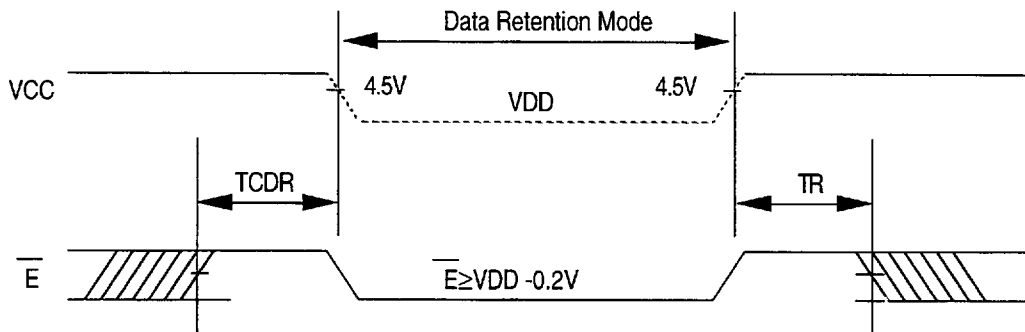
Data Retention Characteristics

EDI88512LP

Characteristic	Sym	Test Conditions	VDD	Min	Typ	Max	Unit
Data Retention Voltage	VDD	$\bar{E} \geq VDD - 0.2V$ $VIN \geq VDD - 0.2V$ or $VIN \leq 0.2V$		2	--	--	V
Data Retention Quiescent Current	ICCDR		2V	--	--	185	μA
Chip Disable to Data Retention Time	TCDR		0	--	--	--	ns
Operation Recovery Time	TR		TAVAV	--	--	--	ms

*Read Cycle Time

**Data Retention
E Controlled**



Ordering Information

Military

Part No. Standard Power	Speed (ns)	Leads	Package Style	No.
EDI88512C55CB	55	32	Dip	9
EDI88512C70CB	70	32	DIP	9
EDI88512C85CB	85	32	DIP	9
EDI88512C100CB	100	32	DIP	9
EDI88512C55NB	55	32	CSOJ	140
EDI88512C70NB	70	32	CSOJ	140
EDI88512C85NB	85	32	CSOJ	140
EDI88512C100NB	100	32	CSOJ	140
EDI88512C55ZB	55	32	Zip	100
EDI88512C70ZB	70	32	ZIP	100
EDI88512C85ZB	85	32	ZIP	100
EDI88512C100ZB	100	32	ZIP	100

For Commercial or Industrial grade product use C or I, respectively to replace B in the suffix of the part number, eg EDI88512C100CB becomes EDI88512C100CI (Industrial Temp range)

Military (Temperature Range Only)

Part No. Standard Power	Speed (ns)	Leads	Package Style	No.
EDI88512C55PM	55	32	DIP	11
EDI88512C70PM	70	32	DIP	11
EDI88512C85PM	85	32	DIP	11
EDI88512C100PM	100	32	DIP	11

Industrial

Part No. Standard Power	Speed (ns)	Leads	Package Style	No.
EDI88512C55PI	55	32	Dip	11
EDI88512C70PI	70	32	DIP	11
EDI88512C85PI	85	32	DIP	11
EDI88512C100PI	100	32	DIP	11

Low Power with Data Retention	Speed (ns)	Leads	Package Style	No.
EDI88512LP55CB	55	32	DIP	9
EDI88512LP70CB	70	32	DIP	9
EDI88512LP85CB	85	32	DIP	9
EDI88512LP100CB	100	32	DIP	9
EDI88512LP55NB	55	32	CSOJ	140
EDI88512LP70NB	70	32	CSOJ	140
EDI88512LP85NB	85	32	CSOJ	140
EDI88512LP100NB	100	32	CSOJ	140
EDI88512LP55ZB	55	32	ZIP	100
EDI88512LP70ZB	70	32	ZIP	100
EDI88512LP85ZB	85	32	ZIP	100
EDI88512LP100ZB	100	32	ZIP	100

Military (Temperature Range Only)

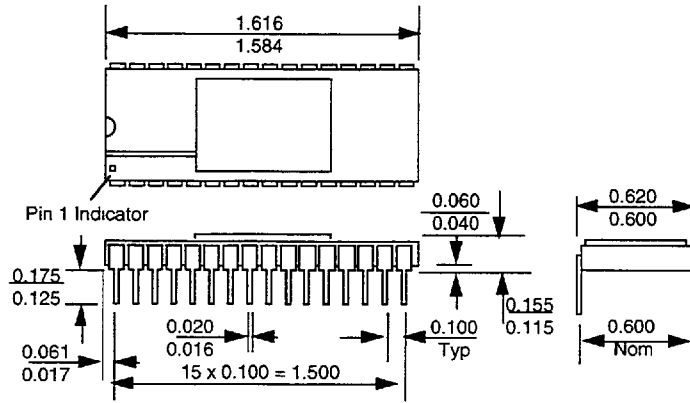
Low Power with Data Retention	Speed (ns)	Leads	Package Style	No.
EDI88512LP55PM	55	32	DIP	11
EDI88512LP70PM	70	32	DIP	11
EDI88512LP85PM	85	32	DIP	11
EDI88512LP100PM	100	32	DIP	11

Industrial

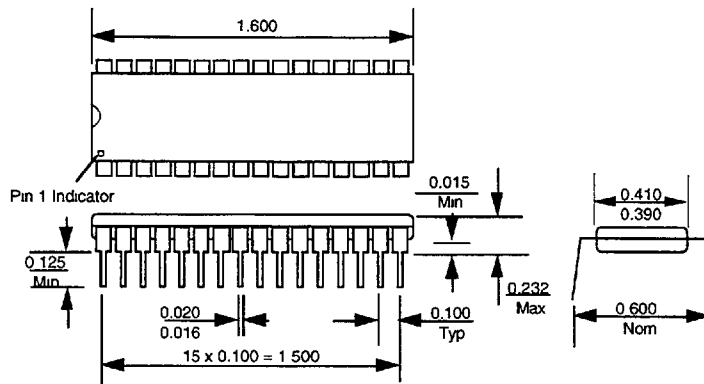
Low Power with Data Retention	Speed (ns)	Leads	Package Style	No.
EDI88512LP55PI	55	32	DIP	11
EDI88512LP70PI	70	32	DIP	11
EDI88512LP85PI	85	32	DIP	11
EDI88512LP100PI	100	32	DIP	11

Package Description

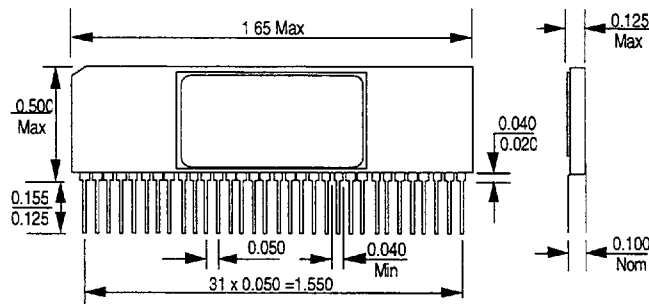
Package No. 9
32 Pin Sidebrazed Ceramic
Dual-in-line Package



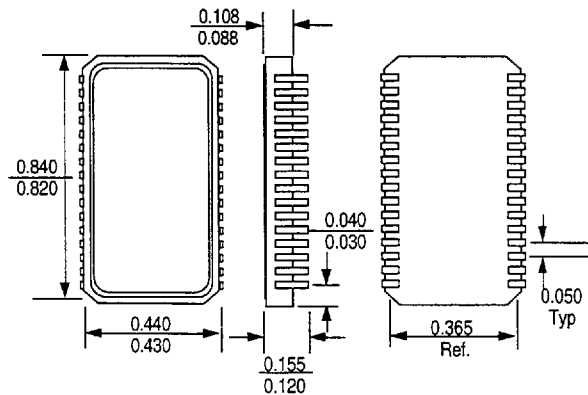
Package No. 11
32 Pin Plastic
Dual-in-line Package



Package No. 100
32 Pin Ceramic
ZIP Package



Package No. 140
32 Lead Ceramic
SOJ Package



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